



SPECIFICATION

• Supplier : Samsung electro-mechanics • Samsung P/N : CL10B122KB8NFNC

• Product : Multi-layer Ceramic Capacitor • Description : CAP, 1.2nF, 50V, ±10%, X7R, 0603

A. Samsung Part Number

<u>CL</u> <u>10</u> <u>B</u> <u>122</u> <u>K</u> <u>B</u> <u>8</u> <u>N</u> <u>F</u> <u>N</u> <u>C</u> ① ② ③ ④ ⑤ ⑥ ⑦ 8 ⑨ ⑩ ⑪

1	Series	Samsung Multi-layer Ceramic Capacitor			
2	Size	0603 (inch code)	L: 1.6 ± 0.1 mm	W: 0.8 ± 0.1 mm	
3	Dielectric	X7R	Inner electrode	Ni	
4	Capacitance	1.2 nF	Termination	Cu	
(5)	Capacitance	±10 %	Plating	Sn 100% (Pb Free)	
	tolerance		Product	Product for POWER application	n
6	Rated Voltage	50 V	Special	Reserved for future use	
7	Thickness	0.8 ± 0.1 mm	① Packaging	Cardboard Type,7"reel(4,000ea	a)

B. Samsung Reliability Test and Judgement condition

	Performance	Test condition	
Capacitance	Within specified tolerance	1kHz±10% 1.0±0.2Vrms	
Tan δ (DF)	0.025 max.		
Insulation	More than 500Mohm⋅ <i>μ</i> F	Rated Voltage 60~120 sec.	
Resistance			
Appearance	No abnormal exterior appearance	Visual inspection	
Withstanding	No dielectric breakdown or	250% of the rated voltage	
Voltage	mechanical breakdown		
Temperature X7R			
Characteristics	(From -55 ℃ to 125 ℃, Capacitance change should be within ±15%)		
Adhesive Strength	No peeling shall be occur on the	500g·F, for 10±1 sec.	
of Termination	terminal electrode		
Bending Strength	Capacitance change : within ±12.5%	Bending to the limit (1mm)	
		with 1.0mm/sec.	
Solderability	More than 75% of terminal surface	SnAg3.0Cu0.5 solder	
	is to be soldered newly	245±5℃, 3±0.3sec.	
		(preheating : 80~120 ℃ for 10~30sec.)	
Resistance to	Capacitance change: within ±7.5%	Solder pot : 270±5℃, 10±1sec.	
Soldering heat	Tan δ, IR : initial spec.		

	Performance	Test condition
Vibration Test	Capacitance change: within ±5%	Amplitude : 1.5mm
	Tan δ, IR : initial spec.	From 10Hz to 55Hz (return : 1min.)
		2hours × 3 direction (x, y, z)
Moisture	Capacitance change: within ±12.5%	With rated voltage
Resistance	Tan δ : 0.05 max	40±2℃, 90~95%RH, 500+12/-0 hours.
IR : More than 25MΩ·μF		
High Temperature	Capacitance change: within ±12.5%	With 200% of the rated voltage
Resistance	Tan δ : 0.05 max	Max. operating temperature
	IR : More than 50MΩ·μF	
		1000+48/-0 hours.
Temperature	Capacitance change: within ±7.5%	1 cycle condition
Cycling	Tan δ, IR : initial spec.	Min. operating temperature → 25°C
		→ Max. operating temperature → 25°C
		5 cycles test

C. Recommended Soldering method :

Reflow (Reflow Peak Temperature : 260+0/-5 $^{\circ}$ C , 10sec. Max)

^{*} For the more detail Specification, Please refer to the Samsung MLCC catalogue.